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Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	8962
Number of Logic Elements/Cells	190000
Total RAM Bits	13284352
Number of I/O	544
Number of Gates	-
Voltage - Supply	1.07V ~ 1.13V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA Exposed Pad
Supplier Device Package	1152-FBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5agxfa5h4f35c5n

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Operating Conditions	2-1
Operating Conditions Switching Characteristics Transceiver Performance Specifications Core Performance Specifications Periphery Performance Configuration Specification POR Specifications TAC Configuration Specifications	2-21
Transceiver Performance Specifications	2-21
Core Performance Specifications	2-37
Periphery Performance	2-44
Configuration Specification	2-56
POR Specifications	2-56
JTAG Configuration Specifications	2-57
Fast Passive Parallel (FPP) Configuration Timing	2-57
Active Serial Configuration Timing	2-65
Active Serial Configuration Timing Passive Serial Configuration Timing	2-67
Initialization	2-69
Initialization	2-69
Remote System Upgrades Circuitry Timing Specification	2-70
User Watchdog Internal Oscillator Frequency Specification	2-71
User Watchdog Internal Oscillator Frequency Specification	2-71
Programmable IOE Delay	2-72
Programmable Output Buffer Delay	272.
Glossary	2-73
Document Revision History	2-78

I/O Standard Specifications

Tables in this section list the input voltage (V_{IH} and V_{IL}), output voltage (V_{OH} and V_{OL}), and current drive characteristics (I_{OH} and I_{OL}) for various I/O standards supported by Arria V devices.

You must perform timing closure analysis to determine the maximum achievable frequency for general purpose I/O standards.

Single-Ended I/O Standards

Table 1-14: Single-Ended I/O Standards for Arria V Devices

I/O Standard	V _{CCIO} (V)		V _{IL} (V)		V _{IH} (V)		V _{OL} (V)	V _{OH} (V)	I _{OL} ⁽¹³⁾	I _{OH} ⁽¹³⁾ (mA)	
1/O Standard	Min	Тур	Max	Min	Max	Min	Max	Max	Min	(mA)	I _{OH} ⁽¹²)
3.3-V LVTTL	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.45	2.4	4	-4
3.3-V LVCMOS	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.2	V _{CCIO} - 0.2	2	-2
3.0-V LVTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
3.0-V LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	V _{CCIO} - 0.2	0.1	-0.1
3.0-V PCI	2.85	3	3.15	_	$0.3 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{\rm CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	_	$0.35 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{\rm CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{\rm CCIO} + 0.3$	0.45	V _{CCIO} - 0.45	2	-2
1.5 V	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{\rm CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
1.2 V	1.14	1.2	1.26	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{\rm CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2

To meet the I_{OL} and I_{OH} specifications, you must set the current strength settings accordingly. For example, to meet the 3.3-V LVTTL specification (4 mA), you should set the current strength settings to 4 mA. Setting at lower current strength may not meet the I_{OL} and I_{OH} specifications in the datasheet.

Arria V GX, GT, SX, and ST Device Datasheet

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Symbol/Description	Condition	Т	Unit		
Symbol/Description	Condition	Min	Тур	Max	Offic
Data rate (10-Gbps transceiver) ⁽⁴⁴⁾	_	0.611	_	10.3125	Gbps
Absolute V _{MAX} for a receiver pin ⁽⁴⁵⁾	_	_	_	1.2	V
Absolute V _{MIN} for a receiver pin	_	-0.4	_	_	V
Maximum peak-to-peak differential input voltage $V_{\rm ID}$ (diff p-p) before device configuration	_	_	_	1.6	V
Maximum peak-to-peak differential input voltage $V_{\rm ID}$ (diff p-p) after device configuration	_	_	_	2.2	V
Minimum differential eye opening at the receiver serial input pins (46)	_	100	_	_	mV
V _{ICM} (AC coupled)	_	_	750 ⁽⁴⁷⁾ /800	_	mV
V _{ICM} (DC coupled)	≤ 3.2Gbps ⁽⁴⁸⁾	670	700	730	mV
	85-Ω setting		85		Ω
Differential on-chip termination	100-Ω setting		100		Ω
resistors	120-Ω setting		120		Ω
	150- Ω setting		150		Ω
t _{LTR} ⁽⁴⁹⁾	_	_	_	10	μs
$t_{\mathrm{LTD}}^{(50)}$	_	4	_	_	μs

⁽⁴⁵⁾ The device cannot tolerate prolonged operation at this absolute maximum.

Arria V GX, GT, SX, and ST Device Datasheet

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⁽⁴⁶⁾ The differential eye opening specification at the receiver input pins assumes that you have disabled the **Receiver Equalization** feature. If you enable the **Receiver Equalization** feature, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.

 $^{^{(47)}\,}$ The AC coupled V_{ICM} is 750 mV for PCIe mode only.

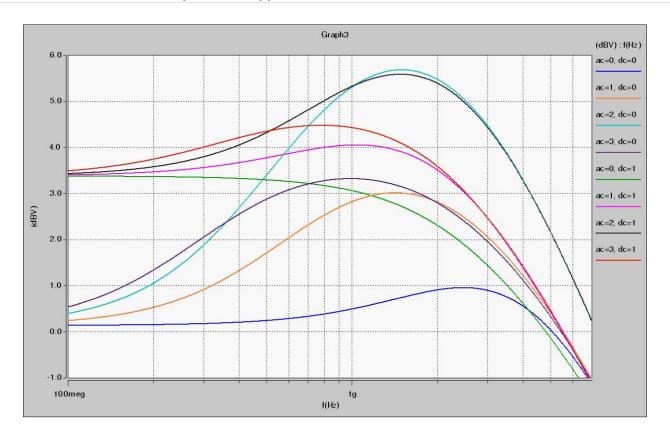
⁽⁴⁸⁾ For standard protocol compliance, use AC coupling.

 t_{LTR} is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.

⁽⁵⁰⁾ t_{LTD} is time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high.

CTLE Response at Data Rates ≤ 3.25 Gbps across Supported AC Gain and DC Gain

Figure 1-3: CTLE Response at Data Rates ≤ 3.25 Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices



Altera Corporation Arria V GX, GT, SX, and ST Device Datasheet



Quartus Prime 1st		Quartus Prime V _{OD} Setting						
Post Tap Pre- Emphasis Setting	10 (200 mV)	20 (400 mV)	30 (600 mV)	35 (700 mV)	40 (800 mV)	45 (900 mV)	50 (1000 mV)	Unit
16	_	_	9.56	7.73	6.49	_	_	dB
17	_	_	10.43	8.39	7.02	_	_	dB
18	_	_	11.23	9.03	7.52	_	_	dB
19	_	_	12.18	9.7	8.02	_	_	dB
20	_	_	13.17	10.34	8.59	_	_	dB
21	_	_	14.2	11.1	_	_	_	dB
22	_	_	15.38	11.87	_	_	_	dB
23	_	_	_	12.67	_	_	_	dB
24	_	_	_	13.48	_	_	_	dB
25	_	_	_	14.37	_	_	_	dB
26	_	_	_	_	_	_	_	dB
27	_	_	_	_	_	_	_	dB
28	_	_	_	_	_	_	_	dB
29	_	_	_	_	_	_	_	dB
30	_	_	_	_	_	_	_	dB
31	_	_	_	_	_	_	_	dB

Related Information

SPICE Models for Altera Devices

Provides the Arria V HSSI HSPICE models.

Transceiver Compliance Specification

The following table lists the physical medium attachment (PMA) specification compliance of all supported protocol for Arria V GX, GT, SX, and ST devices. For more information about the protocol parameter details and compliance specifications, contact your Altera Sales Representative.

Altera Corporation Arria V GX, GT, SX, and ST Device Datasheet



Symbol	Parameter	Condition	Min	Тур	Max	Unit
		−3 speed grade	5	_	800(61)	MHz
¢	Input alogh from on av	-4 speed grade	5	_	800 ⁽⁶¹⁾	MHz
f_{IN}	Input clock frequency	−5 speed grade	5	_	750 ⁽⁶¹⁾	MHz
		-6 speed grade	5	_	625(61)	MHz
f_{INPFD}	Integer input clock frequency to the phase frequency detector (PFD)	_	5	_	325	MHz
f_{FINPFD}	Fractional input clock frequency to the PFD	_	50	_	160	MHz
		−3 speed grade	600	_	1600	MHz
f _{VCO} ⁽⁶²⁾	PLL voltage-controlled oscillator	−4 speed grade	600	_	1600	MHz
IACO	(VCO) operating range	−5 speed grade	600	_	1600	MHz
		-6 speed grade	600	_	1300	MHz
$t_{EINDUTY}$	Input clock or external feedback clock input duty cycle	_	40	_	60	%
		-3 speed grade	_	_	500(63)	MHz
¢	Output frequency for internal global or	−4 speed grade	_	_	500(63)	MHz
f_{OUT}	regional clock	−5 speed grade	_	_	500(63)	MHz
		−6 speed grade	_	_	400(63)	MHz

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Arria V GX, GT, SX, and ST Device Datasheet

⁽⁶¹⁾ This specification is limited in the Quartus Prime software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.

The VCO frequency reported by the Quartus Prime software takes into consideration the VCO post-scale counter κ value. Therefore, if the counter κ has a value of 2, the frequency reported can be lower than the f_{VCO} specification.

This specification is limited by the lower of the two: I/O f_{MAX} or F_{OUT} of the PLL.

DPA Lock Time Specifications

Figure 1-4: Dynamic Phase Alignment (DPA) Lock Time Specifications with DPA PLL Calibration Enabled

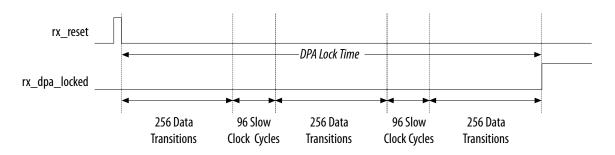


Table 1-41: DPA Lock Time Specifications for Arria V Devices

The specifications are applicable to both commercial and industrial grades. The DPA lock time is for one channel. One data transition is defined as a 0-to-1 or 1-to-0 transition.

Standard	Training Pattern	Number of Data Transitions in One Repetition of the Training Pattern	Number of Repetitions per 256 Data Transitions ⁽⁸⁴⁾	Maximum Data Transition
SPI-4	0000000001111111111	2	128	640
Parallel Rapid I/O	00001111	2	128	640
r araner Kapid 1/O	10010000	4	64	640
Miscellaneous	10101010	8	32	640
iviliscentaneous	01010101	8	32	640

⁽⁸⁴⁾ This is the number of repetitions for the stated training pattern to achieve the 256 data transitions.

LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specifications

Figure 1-5: LVDS Soft-Clock Data Recovery (CDR)/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate Equal to 1.25 Gbps

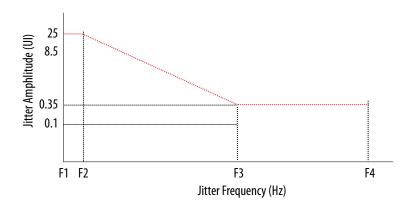


Table 1-42: LVDS Soft-CDR/DPA Sinusoidal Jitter Mask Values for a Data Rate Equal to 1.25 Gbps

Jitter Freq	uency (Hz)	Sinusoidal Jitter (UI)
F1	10,000	25.000
F2	17,565	25.000
F3	1,493,000	0.350
F4	50,000,000	0.350

Initialization

Table 1-71: Initialization Clock Source Option and the Maximum Frequency for Arria V Devices

Initialization Clock Source	Configuration Scheme	Maximum Frequency (MHz)	Minimum Number of Clock Cycles
Internal Oscillator	AS, PS, and FPP	12.5	
CLKUSR ⁽¹⁰⁷⁾	PS and FPP	125	T
	AS	100	$\mathrm{T_{init}}$
DCLK	PS and FPP	125	

Configuration Files

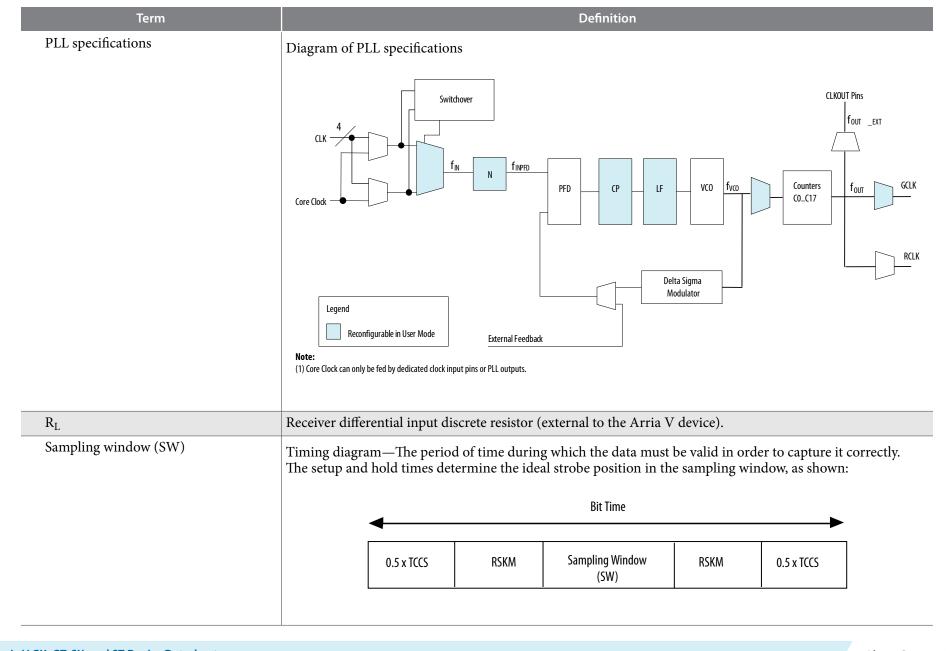
Table 1-72: Uncompressed .rbf Sizes for Arria V Devices

Use this table to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal file (.hex) or tabular text file (.ttf) format, have different file sizes.

For the different types of configuration file and file sizes, refer to the Quartus Prime software. However, for a specific version of the Quartus Prime software, any design targeted for the same device has the same uncompressed configuration file size.

The IOCSR raw binary file (.rbf) size is specifically for the Configuration via Protocol (CvP) feature.

⁽¹⁰⁷⁾ To enable CLKUSR as the initialization clock source, turn on the **Enable user-supplied start-up clock (CLKUSR)** option in the Quartus Prime software from the **General** panel of the **Device and Pin Options** dialog box.



Arria V GX, GT, SX, and ST Device Datasheet

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Date	Version	Changes
June 2012	2.0	 Updated for the Quartus II software v12.0 release: Restructured document. Updated "Supply Current and Power Consumption" section. Updated Table 20, Table 21, Table 24, Table 25, Table 26, Table 35, Table 39, Table 43, and Table 52. Added Table 22, Table 23, and Table 33. Added Figure 1–1 and Figure 1–2. Added "Initialization" and "Configuration Files" sections.
February 2012	1.3	 Updated Table 2–1. Updated Transceiver-FPGA Fabric Interface rows in Table 2–20. Updated V_{CCP} description.
December 2011	1.2	Updated Table 2–1 and Table 2–3.
November 2011	1.1	 Updated Table 2–1, Table 2–19, Table 2–26, and Table 2–36. Added Table 2–5. Added Figure 2–4.
August 2011	1.0	Initial release.

Symbol	Description	Condition	Minimum ⁽¹¹⁴⁾	Typical	Maximum ⁽¹¹⁴⁾	Unit
V_{I}	DC input voltage	_	-0.5	_	3.6	V
V_{O}	Output voltage	_	0	_	V _{CCIO}	V
Т_	Operating junction temperature	Commercial	0	_	85	°C
1 J		Industrial	-40	_	100	°C
t	Power supply ramp time	Standard POR	200 μs	_	100 ms	_
t _{RAMP}		Fast POR	200 μs	_	4 ms	_

Recommended Transceiver Power Supply Operating Conditions

Table 2-6: Recommended Transceiver Power Supply Operating Conditions for Arria V GZ Devices

Symbol	Description	Minimum ⁽¹¹⁸⁾	Typical	Maximum ⁽¹¹⁸⁾	Unit
V_{CCA_GXBL}	Transceiver channel PLL power supply (left side)	2.85	3.0	3.15	V
(119), (120)	Transceiver channer FLL power supply (left side)	2.375	2.5	2.625	
V _{CCA} _GXBR (119), (120)	Transceiver channel PLL power supply (right side)	2.85	3.0	3.15	V
GXBR (119), (120)	Transcerver chainler FLL power supply (right side)	2.375	2.5	2.625	
V _{CCHIP_L}	Transceiver hard IP power supply (left side)	0.82	0.85	0.88	V
V _{CCHSSI_L}	Transceiver PCS power supply (left side)	0.82	0.85	0.88	V
V _{CCHSSI_R}	Transceiver PCS power supply (right side)	0.82	0.85	0.88	V

⁽¹¹⁴⁾ The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Altera Corporation

Arria V GZ Device Datasheet



⁽¹¹⁸⁾ This value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

This supply must be connected to 3.0 V if the CMU PLL, receiver CDR, or both, are configured at a base data rate > 6.5 Gbps. Up to 6.5 Gbps, you can connect this supply to either 3.0 V or 2.5 V.

⁽¹²⁰⁾ When using ATX PLLs, the supply must be 3.0 V.

I/O Standard Specifications

The V_{OL} and V_{OH} values are valid at the corresponding I_{OH} and I_{OL} , respectively.

Table 2-16: Single-Ended I/O Standards for Arria V GZ Devices

I/O Standard		V _{CCIO} (V)		V _{II}	_(V)	V _{IH}	(V)	V _{OL} (V)	V _{OH} (V)	I _{OL} (mA)	I _{OH} (mA)
i/O Staildaid	Min	Тур	Max	Min	Max	Min	Max	Max	Min	IOL (IIIA)	IOH (IIIA)
LVTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	V _{CCIO} - 0.2	0.1	-0.1
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	$0.35 \times V_{\rm CCIO}$	$0.65 \times V_{\rm CCIO}$	V _{CCIO} + 0.3	0.45	V _{CCIO} - 0.45	2	-2
1.5 V	1.425	1.5	1.575	-0.3	$0.35 \times V_{\rm CCIO}$	$0.65 \times V_{\rm CCIO}$	V _{CCIO} + 0.3	$0.25 \times V_{\rm CCIO}$	$0.75 \times V_{\text{CCIO}}$	2	-2
1.2 V	1.14	1.2	1.26	-0.3	$0.35 \times V_{\rm CCIO}$	$0.65 \times V_{\rm CCIO}$	V _{CCIO} + 0.3	$\begin{array}{c} 0.25 \times \\ V_{\rm CCIO} \end{array}$	$0.75 \times V_{\text{CCIO}}$	2	-2

Table 2-17: Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications for Arria V GZ Devices

I/O Standard	V _{CCIO} (V)				V _{REF} (V)		V _{TT} (V)			
i/O Standard	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
SSTL-2 Class I, II	2.375	2.5	2.625	$0.49 \times V_{CCIO}$	$\begin{array}{c} 0.5 \times \\ V_{\rm CCIO} \end{array}$	$0.51 \times V_{\rm CCIO}$	V _{REF} - 0.04	V_{REF}	V _{REF} + 0.04	
SSTL-18 Class I, II	1.71	1.8	1.89	0.833	0.9	0.969	V _{REF} - 0.04	V_{REF}	V _{REF} + 0.04	
SSTL-15 Class I, II	1.425	1.5	1.575	$0.49 \times V_{CCIO}$	$\begin{array}{c} 0.5 \times \\ V_{\rm CCIO} \end{array}$	$0.51 \times V_{\rm CCIO}$	$\begin{array}{c} 0.49 \times \\ V_{CCIO} \end{array}$	0.5 × VCCIO	$0.51 \times V_{CCIO}$	



I/O Standard		V _{CCIO} (\	/)	V _{DIF}	_(DC) (V)		$V_{X(AC)}(V)$		V _{CN}	_{M(DC)} (V)	V	_{DIF(AC)} (V)
1/O Standard	Min	Тур	Max	Min	Max	Min	Тур	Max	Min	Тур	Max	Min	Max
HSTL-12 Class I, II	1.14	1.2	1.26	0.16	V _{CCIO} + 0.3	_	$0.5 \times V_{CCIO}$	_	$0.4 \times V_{\rm CCIO}$	0.5 × V _{CC} IO	$0.6 \times V_{\text{CCIO}}$	0.3	V _{CCIO} + 0.48
HSUL-12	1.14	1.2	1.3	0.26	0.26	0.5 × V _{CCIO} – 0.12	$0.5 \times V_{CCIO}$	$0.5 \times V_{\rm CCIO} \\ + 0.12$	$0.4 \times V_{\rm CCIO}$	0.5 × V _{CC}	0.6 × V _{CCIO}	0.44	0.44

Table 2-21: Differential I/O Standard Specifications for Arria V GZ Devices

I/O Standard	V _{CCIO} (V) ⁽¹²⁸⁾		V _{ID} (mV) ⁽¹²⁹⁾			V _{ICM(DC)} (V)		V _{OD} (V) ⁽¹³⁰⁾			V _{OCM} (V) ⁽¹³⁰⁾				
i/O Standard	Min	Тур	Max	Min	Condition	Max	Min	Condition	Max	Min	Тур	Max	Min	Тур	Max
PCML	PCML Transmitter, receiver, and input reference clock pins of the high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to the "Transceiver Performance Specifications" section.														
2.5 V LVDS	2.375	2.5	2.625	100	V _{CM} =	_	0.05	D _{MAX} ≤ 700 Mbps	1.8	0.247	_	0.6	1.125	1.25	1.375
(131)	2.373	2.3	2.023	100	1.25 V	_	1.05	D _{MAX} > 700 Mbps	1.55	0.247	_	0.6	1.125	1.25	1.375
BLVDS (132)	2.375	2.5	2.625	100	_	_	_	_	_	_	_	_	_	_	_

 $^{^{\}left(128\right)}\,$ Differential inputs are powered by VCCPD which requires 2.5 V.



⁽¹²⁹⁾ The minimum VID value is applicable over the entire common mode range, VCM.

⁽¹³⁰⁾ RL range: $90 \le RL \le 110 \Omega$.

⁽¹³¹⁾ For optimized LVDS receiver performance, the receiver voltage input range must be between 0.25 V to 1.6 V for data rates above 700 Mbps, and 0 V to 1.85 V for data rates below 700 Mbps.

⁽¹³²⁾ There are no fixed V_{ICM}, V_{OD}, and V_{OCM} specifications for BLVDS. They depend on the system topology.

Switching Characteristics

Transceiver Performance Specifications

Reference Clock

Table 2-22: Reference Clock Specifications for Arria V GZ Devices

Speed grades shown refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the *Arria V Device Overview*.

Symbol/Description	Conditions	Transceiver Speed Grade 2			Transce	Unit						
Symbol/Description	Conditions	Min	Тур	Max	Min	Тур	Max	Offic				
Reference Clock												
Supported I/O Standards	Dedicated reference clock pin	10										
	RX reference clock pin	RX reference clock pin 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS										
Input Reference Clock Frequency (CMU PLL) (137)	_	40	_	710	40	_	710	MHz				
Input Reference Clock Frequency (ATX PLL) ⁽¹³⁷⁾	_	100	_	710	100	_	710	MHz				



 $^{^{(137)}}$ The input reference clock frequency options depend on the data rate and the device speed grade.

Symbol	V _{OD} Setting	V _{OD} Value (mV)	V _{OD} Setting	V _{OD} Value (mV)
	15	300	47	940
	16	320	48	960
	17	340	49	980
	18	360	50	1000
	19	380	51	1020
	20	400	52	1040
	21	420	53	1060
	22	440	54	1080
$ m V_{OD}$ differential peak to peak typical	23	460	55	1100
	24	480	56	1120
	25	500	57	1140
	26	520	58	1160
	27	540	59	1180
	28	560	60	1200
	29	580	61	1220
	30	600	62	1240
	31	620	63	1260



Core Performance Specifications

Clock Tree Specifications

Table 2-33: Clock Tree Performance for Arria V GZ Devices

Symbol	Perfor	Unit	
Symbol	C3, I3L	C4, I4	Offic
Global and Regional Clock	650	580	MHz
Periphery Clock	500	500	MHz

PLL Specifications

Table 2-34: PLL Specifications for Arria V GZ Devices

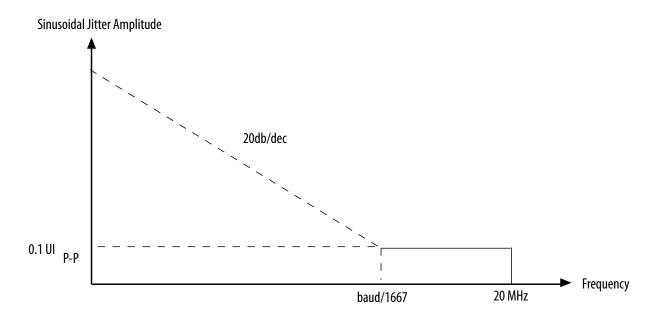
Symbol	Parameter	Min	Тур	Max	Unit
f _{IN} ⁽¹⁶⁷⁾	Input clock frequency (C3, I3L speed grade)	5	_	800	MHz
IIN	Input clock frequency (C4, I4 speed grade)	5	_	650	MHz
f _{INPFD}	Input frequency to the PFD	5	_	325	MHz
$f_{ m FINPFD}$	Fractional Input clock frequency to the PFD	50	_	160	MHz
f _{VCO} (168)	PLL VCO operating range (C3, I3L speed grade)	600	_	1600	MHz
IVCO ()	PLL VCO operating range (C4, I4 speed grade)	600	_	1300	MHz
t _{EINDUTY}	Input clock or external feedback clock input duty cycle	40	_	60	%

⁽¹⁶⁷⁾ This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.



⁽¹⁶⁸⁾ The VCO frequency reported by the Quartus II software in the **PLL Usage Summary** section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the f_{VCO} specification.

Figure 2-5: LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate < 1.25 Gbps



Non DPA Mode High-Speed I/O Specifications

Table 2-46: High-Speed I/O Specifications for Arria V GZ Devices

When J = 3 to 10, use the serializer/deserializer (SERDES) block.

When J = 1 or 2, bypass the SERDES block.

Symbol	Conditions		C3, I3L			Unit		
Зутро і	Conditions	Min	Тур	Max	Min	Тур	Max	Onit
Sampling Window	_	_	_	300	_	_	300	ps

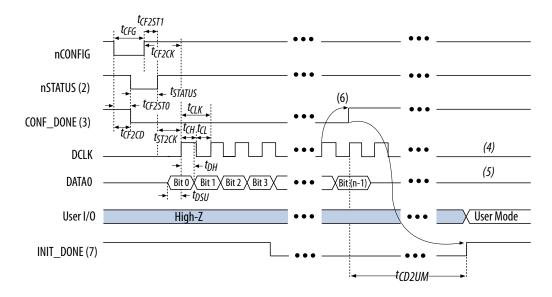
Altera Corporation Arria V GZ Device Datasheet



Passive Serial Configuration Timing

Figure 2-10: PS Configuration Timing Waveform

Timing waveform for a passive serial (PS) configuration when using a MAX II device, MAX V device, or microprocessor as an external host.



Notes:

- 1. The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF_DONE are at logic high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- 2. After power-up, the Arria V GZ device holds nSTATUS low for the time of the POR delay.
- 3. After power-up, before and during configuration, CONF_DONE is low.
- 4. Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.
- 5. DATA0 is available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings in the Device and Pins Option.
- 6. To ensure a successful configuration, send the entire configuration data to the Arria V GZ device. CONF_DONE is released high after the Arria V GZ device receives all the configuration data successfully. After CONF_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- 7. After the option bit to enable the INIT_DONE pin is configured into the device, the INIT_DONE goes low.



Term	Definition
V_{OCM}	Output common mode voltage—The common mode of the differential signal at the transmitter.
V _{OD}	Output differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter.
V _{SWING}	Differential input voltage
V_{X}	Input differential cross point voltage
V _{OX}	Output differential cross point voltage
W	High-speed I/O block—clock boost factor

Document Revision History

Date	Version	Changes
February 2017	2017.02.10	 Changed the minimum value for t_{CD2UMC} in the "FPP Timing Parameters for Arria V GZ Devices When the DCLK-to-DATA[] Ratio is 1" table. Changed the minimum value for t_{CD2UMC} in the "FPP Timing Parameters for Arria V GZ Devices When the DCLK-to-DATA[] Ratio is >1" table.
		 Changed the minimum value for t_{CD2UMC} in the "AS Timing Parameters for AS x1 and AS x4 Configurations in Arria V GZ Devices" table. Changed the minimum value for t_{CD2UMC} in the "PS Timing Parameters for Arria V GZ Devices" table. Changed the minimum number of clock cycles value in the "Initialization Clock Source Option and the Maximum Frequency for Arria V GZ Devices" table.

Altera Corporation Arria V GZ Device Datasheet

